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Silicon PNP Epitaxial

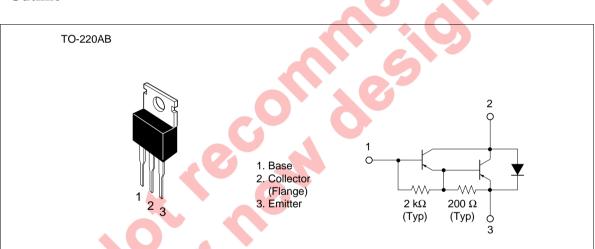
## RENESAS

ADE-208-858 (Z) 1st. Edition September 2000

#### Application

Medium speed and power switching complementary pair with 2SD970(K)

#### Outline



#### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

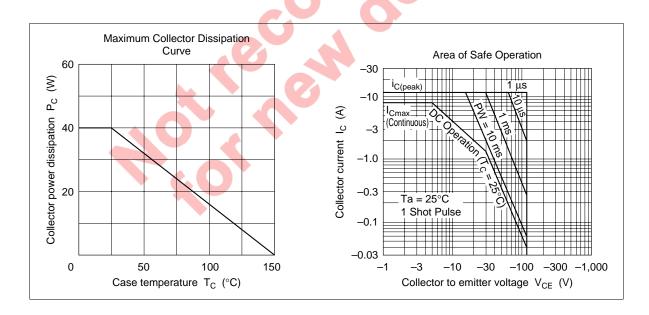
Symbol	Rating	Unit
V <sub>CBO</sub>	-120	V
V <sub>CEO</sub>	-120	V
V <sub>EBO</sub>	-7	V
Ι <sub>c</sub>	-8	А
I <sub>C(peak)</sub>	-12	А
P <sub>c</sub> * <sup>1</sup>	40	W
Tj	150	°C
Tstg	-55 to +150	°C
	V <sub>CBO</sub> V <sub>CEO</sub> V <sub>EBO</sub> I <sub>C</sub> I <sub>C</sub> P <sub>C</sub> * <sup>1</sup> Tj	$\begin{array}{c c} & -120 \\ \hline V_{CBO} & -120 \\ \hline V_{CEO} & -120 \\ \hline V_{EBO} & -7 \\ \hline I_{C} & -8 \\ \hline I_{C(peak)} & -12 \\ \hline P_{C}^{*1} & 40 \\ \hline Tj & 150 \\ \end{array}$

Note: 1. Value at  $T_c = 25^{\circ}C$ 

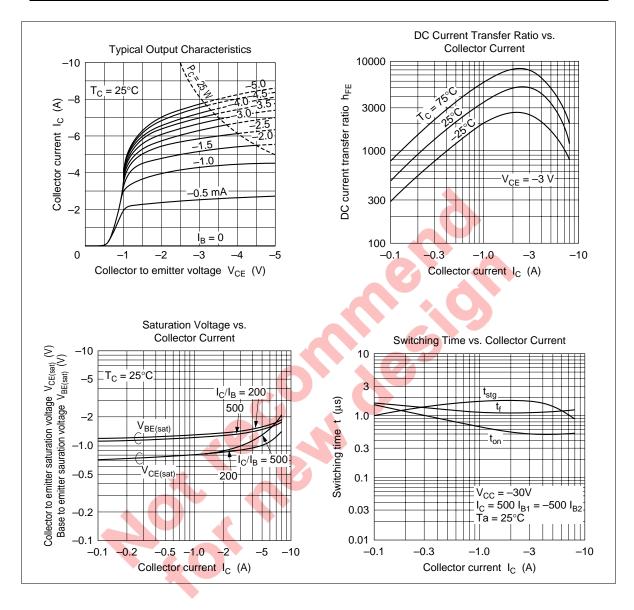
#### **Electrical Characteristics** (Ta = 25°C)

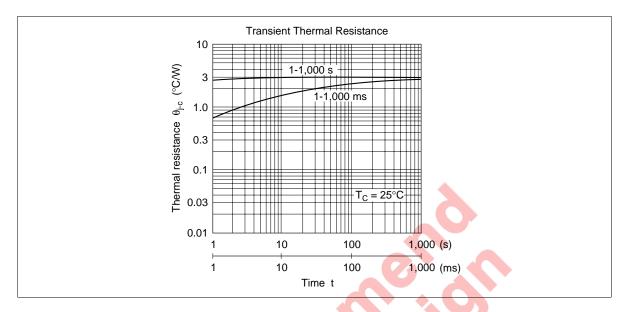
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	-120	_		V	$I_c = -25 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-7	_	_	V	$I_{\rm E} = -50$ mA, $I_{\rm C} = 0$
Collector cutoff current	I <sub>CBO</sub>	—	—	-100	μA	$V_{CB} = -120 \text{ V}, \text{ I}_{E} = 0$
	I <sub>CEO</sub>	—	—	-10	μΑ	$V_{ce} = -100 \text{ V}, \text{ R}_{be} = \infty$
DC current transfer ratio	$h_{\text{FE}}$	1000	—	20000		$V_{CE} = -3 \text{ V}, \text{ I}_{C} = -4 \text{ A}^{*1}$
Collector to emitter saturation	$V_{\text{CE(sat)(1)}}$	—	—	-1.5	V	$I_{\rm c} = -4$ A, $I_{\rm B} = -8$ mA <sup>*1</sup>
voltage	V <sub>CE(sat)(2)</sub>	—	—	-3.0	V	$I_{\rm c} = -8$ A, $I_{\rm B} = -80$ mA <sup>*1</sup>
Base to emitter saturation	$V_{BE(sat)(1)}$	—	—	-2.0	V	$I_{\rm c} = -4$ A, $I_{\rm B} = -8$ mA <sup>*1</sup>
voltage	$V_{\text{BE(sat)(2)}}$	—	—	-3.5	V	$I_{c} = -8 \text{ A}, I_{B} = -80 \text{ mA}^{*1}$
Turn on time	t <sub>on</sub>	_	0.5		μs	$I_{c} = -4 \text{ A}, I_{B1} = I_{B2} = -8 \text{ mA}$
Storage time	t <sub>stg</sub>	_	1.6		μs	
Fall time	t <sub>f</sub>	_	1.5	-	μs	

Note: 1. Pulse test



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